

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:	Cavallaro et al.)	<u>CERTIFICATE OF MAILING BY "EXPRESS MAIL"</u>
Appln No.:)	"Express Mail" Mailing Label Number
)	<u>EV 214 707 752 US</u>
Filed:	Herewith)	Date of Deposit <u>July 10, 2003</u>
Title:	SILICONE DISPENSING WITH A CONFOMAL FILM)	I hereby certify that this paper or fee is being deposited with sufficient postage utilizing the United States Postal Service "Express Mail Post Office to Addressee" Service under 37 CFR §1.10 on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.
Group Art Unit:)	<u>Ed Price</u> (Typed or printed name of person mailing)
Examiner:)	<u>Ed Price</u> (Signature of person mailing)

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In accordance with 37 CFR §§ 1.97 and 1.98, Applicants bring the following information with respect to the above-identified application to the attention of the Examiner.

U.S. Patent Documents

US-6,333,117	12/25/2001	Sumi et al.
US-6,103,271	08/15/2000	Morrison et al.
US-5,910,314	06/08/1999	Benoff et al.
US-5,759,560	06/02/1998	Dillon
US-5,705,174	01/06/1998	Benoff et al.
US-5,407,609	04/18/1995	Tice et al.
US-5,310,721	05/10/1994	Lo
US-4,389,330	06/21/1983	Tice et al.
US-4,384,975	05/24/1983	Fong
US-4,280,833	07/28/1981	Beestman et al.
US-3,891,570	06/24/1975	Fukushima et al.
US-3,577,515	05/04/1971	Vandegaer

Non-Patent Literature Documents

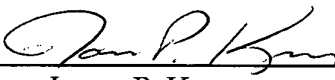
Nakai et al., " <u>Large Area Micro-Encapsulated Reflective Guest-Host LCDs and Their Applications</u> ", <i>Display Materials and Devices Laboratory, Corporate Research and Development Center</i> , Toshiba Corp.
"Microencapsulation Technology", 3M, 1996
Franjione et al. "The Art and Science of Microencapsulation", <i>Technology Today</i> , 1995
"Microencapsulation", <i>Southwest Research Institute</i> , San Antonio, Texas, May 2002
"Microencapsulation", <i>Ciba Speciality Chemicals</i> , www.cibasc.com
"What is Microencapsulation", <i>Thies Technology</i> , www.thiestechnology.com
"Ink Gets an Upgrade", <i>EDN Access</i> , www.e-insite.net
"The European Biomaterials Network, Drug Delivery and Citus's New Microspheres, Microcapsules and Liposomes (MML) Series", www.biomateria.com
Versic, "Flavor Encapsulation", <i>ACS Symposium</i> , Series No. 370. 1998, www.rtdodge.com
"Microcapsules", <i>Nirotek Coated Paper Mfg.</i> , www.nirotek.com
"Microcapsules", <i>Brace GmbH</i> , www.brace.de
"Lucent, E Ink Developing E-Books Using Bell Labs Plastic Transistors", www.bell-labs.com

The above documents are listed on Form PTO/SB/08 which accompanies this Information Disclosure Statement, and a copy of each document listed is enclosed herewith.

Pursuant to 37 CFR § 1.97(h), the filing of this Information Disclosure Statement shall not be construed to be an admission that the information cited in the statement is, or is considered to be, material to patentability as defined in 37 CFR § 1.56(b).

Respectfully submitted,

FITCH, EVEN, TABIN & FLANNERY

By 
James P. Krueger
Registration No. 35,234

Date: July 10, 2003

Suite 1600
120 South LaSalle Street
Chicago, Illinois 60603-3406
(312) 577-7000

PTO/SB/08A Substitute for Form PTO-1449			Application Number		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i>			Filing Date		Herewith
			First Named Inventor		Cavallaro et al.
			Art Unit		
			Examiner Name		
Sheet	1	of	2	Attorney Docket	CE09078R (74086)

U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code ²			
		US-6,333,117	12/25/2001	Sumi et al.	
		US-6,103,271	08/15/2000	Morrison et al.	
		US-5,910,314	06/08/1999	Benoff et al.	
		US-5,759,560	06/02/1998	Dillon	
		US-5,705,174	01/06/1998	Benoff et al.	
		US-5,407,609	04/18/1995	Tice et al.	
		US-5,310,721	05/10/1994	Lo	
		US-4,389,330	06/21/1983	Tice et al.	
		US-4,384,975	05/24/1983	Fong	
		US-4,280,833	07/28/1981	Beestman et al.	
		US-3,891,570	06/24/1975	Fukushima et al.	
		US-3,577,515	05/04/1971	Vandegaer	
		US-			
		US-			

FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Cite No. ¹	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear	T ⁶
		Country Code ³ -Number ⁴ -Kind Code ⁵				

Examiner Signature		Date Considered	
-----------------------	--	--------------------	--

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Applicant's unique citation designation number (optional). ² See Kind Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

PTO/SB/08B Substitute for Form PTO-1449			Application Number		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)			Filing Date		Herewith
			First Named Inventor		Cavallaro et al.
			Art Unit		
			Examiner Name		
Sheet	2	of	2	Attorney Docket	CE09078R (74086)

NON PATENT LITERATURE DOCUMENTS					
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published			T ²
		Nakai et al., "Large Area Micro-Encapsulated Reflective Guest-Host LCDs and Their Applications", <i>Display Materials and Devices Laboratory, Corporate Research and Development Center, Toshiba Corp.</i>			
		"Microencapsulation Technology", <i>3M</i> , 1996			
		Franjone et al. "The Art and Science of Microencapsulation", <i>Technology Today</i> , 1995			
		"Microencapsulation", <i>Southwest Research Institute</i> , San Antonio, Texas, May 2002			
		"Microencapsulation", <i>Ciba Speciality Chemicals</i> , www.cibasc.com			
		"What is Microencapsulation", <i>Thies Technology</i> , www.thiestechnology.com			
		"Ink Gets an Upgrade", <i>EDN Access</i> , www.e-insite.net			
		"The European Biomaterials Network, Drug Delivery and Citus's New Microspheres, Microcapsules and Liposomes (MML) Series, www.biomateria.com			
		Versic, "Flavor Encapsulation", <i>ACS Symposium</i> , Series No. 370. 1998, www.rtdodge.com			
		"Microcapsules", <i>Nirotek Coated Paper Mfg.</i> , www.nirotek.com			
		"Microcapsules", <i>Brace GmbH</i> , www.brace.de			
		"Lucent, E Ink Developing E-Books Using Bell Labs Plastic Transistors", www.bell-labs.com			

Examiner Signature		Date Considered	
-----------------------	--	--------------------	--

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Applicant's unique citation designation number (optional). ² Applicant is to place a check mark here if English language Translation is attached.